



CALL FOR PARTICIPATIONS on a Special International Symposium on

“CURRENT TECHNOLOGY IN ELECTRONIC INDUSTRY”



**The 5th International Conference and Exhibition on Energy and
Advanced Materials
16th – 19th October 2017
Holiday Inn, Melaka, Malaysia**

Website: <http://iceseam2017.utm.edu.my>

Email: iceseam@utm.edu.my

Symposium Focus Track:

Group of Advanced Materials Characterization Laboratory (AMCHAL), Faculty of Mechanical Engineering, Universiti Teknikal Malaysia Melaka and Electronic Packaging Research Society (EPRS) will organize a Special International Symposium on a “Current Technology in Electronic Industry” within The 5th International Conference and Exhibition on Sustainable Energy and Advanced Materials (ICE-SEAM2017), organized by Universiti Teknikal Malaysia Melaka in Melaka from 16th to 19th of October 2017.

The aim of this Special International Symposium is for the researchers, academicians, engineers and postgraduate students from universities, research institutions and industries all around the world to present their findings of their ongoing research on current technologies and trends in electronic industry.

In particular, contributions on the important subjects in current technologies are invited, including, but not limited to: i) electronic packaging, ii) components, iii) circuits, iv) devices and system power, v) energy and vi) industry applications.

Publications:

ALL ACCEPTED FULL PAPER will be published in journal of “Advanced Science Letter” indexed in SCOPUS, and extended version at least 50% changes will be proposed to publish in “Journal of Advanced Manufacturing Technology – Special Issue” indexed by SCOPUS. All submitted papers will be peer review and evaluated based on the originality, research content, technical content, relevance to symposium and readability.

Full Paper Submission Guidelines

Full paper submission guidelines is available at

<http://iceseam2017.utm.edu.my/index.php/submissions-publications>.

When submitting paper in electronic submission system, **please choose Subject Areas “Special Symposium: Electronic Industry”**.

Important Dates

Full paper submission deadline – **31st May 2017**

Notification of acceptance – **30th June 2017**

Early-bird registration deadline – **1st August 2017**

Normal registration deadline – **1st September 2017**

Camera-ready paper submission – **15th August 2017**

Registration Fee

<http://iceseam2017.utm.edu.my/index.php/registration-fees-2>

Symposium Organizer

Group of Advanced Materials Characterization Laboratory

Faculty of Mechanical Engineering

Universiti Teknikal Malaysia Melaka

Contact Us

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Secretariat International Symposium

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